7 37	77.2 L = 1	Coarch Toyt	DB	Time stamp
L Number	Hits 93	Search Text smith-richard-d.in.	USPAT;	2003/01/16 09:59
-	93	Smitti-fittiata-a.in.	US-PGPUB	
	12	smith-richard-d.in. and (electrospray	USPAT;	2003/01/16 14:20
-	13	electro-spray ESI (electro adj spray))	US-PGPUB	
	2	tang-kegi.in.	USPAT;	2003/01/16 10:00
-	2	cany-vedi-in.	US-PGPUB	
	4	lin-washe in	USPAT;	2003/01/16 10:00
-	4	lin-yuehe.in.	US-PGPUB	
	736	(battelle adj memorial adj institute).as.	USPAT;	2003/01/16 10:00
_	730	(bacterie ad) memorial ad, inscreace, as:	US-PGPUB	
	16	((battelle adj memorial adj	USPAT;	2003/01/16 10:01
-	10	institute).as.) and (electrospray	US-PGPUB	
		electro-spray ESI (electro adj spray))		i
_	308	250/288.ccls. and (electrospray	USPAT;	2003/01/16 10:26
	300	electro-spray ESI (electro adj spray))	US-PGPUB	
_	26	(250/288.ccls. and (electrospray	USPAT;	2003/01/16 14:23
		electro-spray ESI (electro adj spray)))	US-PGPUB	
		and ((electrospray electro-spray ESI		
		(electro adj spray)) same array)		
_	81	(250/288.ccls. and (electrospray	USPAT;	2003/01/16 10:04
		electro-spray ESI (electro adj spray)))	US-PGPUB	
		and reservoir		0000100100000
_	19	((250/288.ccls. and (electrospray	USPAT;	2003/01/16 10:26
		electro-spray ESI (electro adj spray)))	US-PGPUB	
		and ((electrospray electro-spray ESI		
		(electro adj spray)) same array)) and		
		((250/288.ccls. and (electrospray		
		electro-spray ESI (electro adj spray)))		
		and reservoir)		2003/01/16 14:10
-	17	(((250/288.ccls. and (electrospray	USPAT;	2003/01/16 14:10
		electro-spray ESI (electro adj spray)))	US-PGPUB	.
		and ((electrospray electro-spray ESI		-
		(electro adj spray)) same array)) and		
	1	((250/288.ccls. and (electrospray		
		electro-spray ESI (electro adj spray)))		
		and reservoir)) and (chip wafer)	USPAT;	2003/01/16 14:31
-	1	6107628.pn.	US-PGPUB	2003, 02, 20 21.02
		(250/288.ccls. and (electrospray	USPAT;	2003/01/16 14:22
_	2	electro-spray ESI (electro adj spray)))	US-PGPUB	
		and (multi-capillary (multi adj		i
		capillary))		
	210		USPAT;	2003/01/16 14:41
-	210	adj spray))) and ((electrospray	US-PGPUB	
		electro-spray ESI (electro adj spray))		!
		same array		
_	1		USPAT;	2003/01/16 14:42
	_	adi spray))) and ((electrospray	US-PGPUB	
		electro-spray ESI (electro adj spray))		
1	1	same array) and (multi-capillary)		1
_	0	((electrospray electro-spray ESI (electro	USPAT;	2003/01/16 14:26
		adi spray))) and ((electrospray	US-PGPUB	
		electro-spray ESI (electro adj spray))		
		same array) and (CF near2 (rf adj plasma))		0000/01/05 5: 55
_	0	(Improved adj Ionization adj Source adj	USPAT;	2003/01/16 14:32
		Utilizing adj2 multi-capillary).ti.	US-PGPUB	
-	0	(Improved adj Ionization adj Source adj	USPAT;	2003/01/16 14:35
		Utilizing\$).ti.	US-PGPUB	0000/00/16 11 31
-	1	DE-AC06-76RL01830	USPAT;	2003/01/16 14:34
			US-PGPUB	2002/01/16 14:36
-	0	(Improved adj Ionization adj Source\$).ti.	USPAT;	2003/01/16 14:35
	l		US-PGPUB	2003/01/16 14:46
-	104	(electrospray electro-spray ESI (electro	USPAT;	2003/01/16 14:46
1		adj spray))) and ((electrospray	US-PGPUB	
		electro-spray ESI (electro adj spray))		
		same (chip wafer)	HCDATT.	2003/01/16 14:53
-	1	((electrospray electro-spray ESI (electro	USPAT; US-PGPUB	2003/01/10 14.03
	1	adj spray))) and ((electrospray	US-FGFUB	1
		electro-spray ESI (electro adj spray))		
	1	same (chip wafer)) and (multi-capillary)		

				0000/01/16 14 53
-	3	(mass adj spectromet\$2) same	USPAT; US-PGPUB	2003/01/16 14:53
	11	(multi-capillary) (mass adj spectromet\$2) and	USPAT;	2003/01/16 20:54
-	11	(multi-capillary)	US-PGPUB	
_	3	multi-capillary adj inlet	USPAT;	2003/01/16 20:13
			US-PGPUB	2002/01/16 10:57
-	0	multi-capillary adj inlet	EPO; JPO;	2003/01/16 18:57
		the state of the second st	DERWENT EPO; JPO;	2003/01/16 19:41
-	1	<pre>multi-capillary and (mass adj spectromet\$2)</pre>	DERWENT	2003,01,10 13.11
_	64	multi-capillary	EPO; JPO;	2003/01/16 20:13
-	01	marci oupling	DERWENT	
-	0	multi-capillary	IBM_TDB	2003/01/16 19:40
-	0	multicapillary	IBM_TDB EPO; JPO;	2003/01/16 19:40
-	20	multicapillary	DERWENT	2003/01/10 13:11
1_	1	multicapillary and (mass adj spectromet\$2)	EPO; JPO;	2003/01/16 19:41
-		marticapiliary and (mass er) species	DERWENT	
_	1	5736740.pn.	USPAT;	2003/01/16 20:08
			US-PGPUB	2003/01/16 20:13
-	49	multicapillary	USPAT; US-PGPUB	2003/01/10 20:13
	6	multicapillary and (mass adj spectromet\$2)	USPAT;	2003/01/16 20:14
1-	6	matercapititaty and (mass day spectromoty)	US-PGPUB	
-	1033	(CF4 (carbon adj tetrafluoride)) same	USPAT;	2003/01/17 11:13
		(silicon chip wafer)	US-PGPUB	2002/01/17 11:02
-	25	((CF4 (carbon adj tetrafluoride)) same	USPAT; US-PGPUB	2003/01/17 11:02
	673	(silicon chip wafer)) and hydrophob\$5 ((CF4 (carbon adj tetrafluoride)) same	USPAT;	2003/01/17 11:14
_	673	(silicon chip wafer)) and (CF4 (carbon adj	US-PGPUB	
		tetrafluoride)) same (plasma)		
_	7	(((CF4 (carbon adj tetrafluoride)) same	USPAT;	2003/01/17 09:29
		(silicon chip wafer)) and hydrophob\$5) and	US-PGPUB	-
		(((CF4 (carbon adj tetrafluoride)) same (silicon chip wafer)) and (CF4 (carbon adj		
		tetrafluoride)) same (plasma))		
_	25	((CF4 (carbon adj tetrafluoride)) same	USPAT;	2003/01/17 09:29
		(silicon chip wafer)) and (mass adj	US-PGPUB	
		spectromet\$2)	USPAT;	2003/01/17 09:29
-	3	((((CF4 (carbon adj tetrafluoride)) same (silicon chip wafer)) and hydrophob\$5) and	US-PGPUB	2003/01/1/ 03/21
İ		(((CF4 (carbon adj tetrafluoride)) same		
		(silicon chip wafer)) and (CF4 (carbon adj		
		tetrafluoride)) same (plasma))) and (((CF4		
		(carbon adj tetrafluoride)) same (silicon		
		<pre>chip wafer)) and (mass adj spectromet\$2)) ((CF4 (carbon adj tetrafluoride)) same</pre>	USPAT;	2003/01/17 09:40
-		(silicon chip wafer)) and (CF4 (carbon adj	US-PGPUB	
		tetrafluoride)) same (hydrophob\$5)		
-	7	(((CF4 (carbon adj tetrafluoride)) same	USPAT;	2003/01/17 11:14
		(silicon chip wafer)) and (CF4 (carbon adj tetrafluoride)) same (plasma)) and	US-PGPUB	
		hydrophob\$5		
_	5	(CF4 (carbon adj tetrafluoride)) same	USPAT;	2003/01/17 11:16
		hydrophob\$5	US-PGPUB	 2003/01/17 10:54
-	1	4749440.pn.	USPAT; US-PGPUB	2003/01/1/ 10:34
	1	4863809.pn.	USPAT;	2003/01/17 10:55
-	1	1000007.pm.	US-PGPUB	
_	1	6465366.pn.	USPAT;	2003/01/17 11:02
			US-PGPUB	2003/01/17 11:14
-	117	(CF4 (carbon adj tetrafluoride)) same (silicon chip wafer)	IBM_TDB	2003/01/1/ 11.13
_	0		IBM TDB	2003/01/17 11:17
	1	(silicon chip wafer)) and (CF4 (carbon adj	_	
		tetrafluoride)) same (plasma)) and		
		hydrophob\$5	IBM TDB	2003/01/17 11:18
-	59	((CF4 (carbon adj tetrafluoride)) same (silicon chip wafer)) and (CF4 (carbon adj	TEM-TOB	2000/01/1/ 11:10
		tetrafluoride)) same (plasma)		
	I	1		

[-	1	(CF4 (carbon adj tetrafluoride)) same	IBM_TDB	2003/01/17 11:18
_	o	moisture (CF4 (carbon adj tetrafluoride)) same	IBM_TDB	2003/01/17 11:18
-	12	hydrophob\$5 (CF4 (carbon adj tetrafluoride)) same hydrophob\$5	EPO; JPO; DERWENT	2003/01/17 11:18
-	0	((CF4 (carbon adj tetrafluoride)) same hydrophob\$5) and (chip wafer)	EPO; JPO; DERWENT	2003/01/17 11:19
-	1	((CF4 (carbon adj tetrafluoride)) same hydrophob\$5) and silicon		2003/01/17 11:19